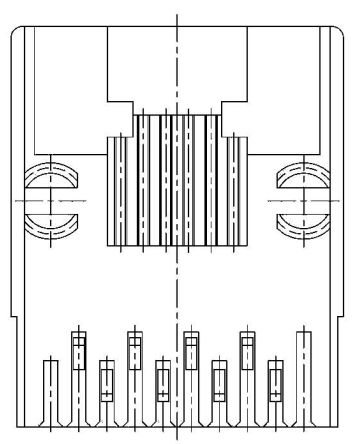


PCB LAYOUT/TOP VIEW



**MATERIALS:**  
 PLASTIC HOUSING: ENGINEERING THERMOPLASTIC  
 FLAMMABILITY RATING UL 94V-0.  
 CONTACTS: PHOSPHOR BRONZE  
 PLATING: GOLD PLATING OVER NICKEL IN CONTACT.  
 TIN PLATING OVER NICKEL IN SOLDER AREA.

|                        |                   |   |  |
|------------------------|-------------------|---|--|
| RoHS Compliant         |                   | <b>HSM</b> 玄茂科技股份有限公司<br>HSUAN MAO TECHNOLOGY CO., LTD.                     |  |
| APPD. 核准               | SCALE 比例 参考       | 容許公差 TOLERANCE<br>.XXX ±0.10<br>.XX ±0.25<br>.X ±0.38<br>X ±0.50<br>ANG ±3° | PART NAME 品名<br>SIDE ENTRY PCB DIP JACK 10P8C<br>WITHOUT SHIELDED WITH SPLIT FOOT<br>FLAT PIN BLACK INSULATOR ROHS |
| DWG. 製圖<br>Betty       | UNIT 單位<br>MM     | SIZE 紙張尺寸<br>A 4  | PART NO.<br>料號 C0077-08PPXB00R   |
| DATE 制表日<br>2014/09/11 | PAGE 張數<br>1 OF 1 | REV. 版次<br>A  |  |